

9/8/60

IN THE UNITED STATES
PATENT AND TRADEMARK OFFICE

PATENT APPLICATION

Robert Evan Myer

CASE 72

TITLE Improved RF Test Probe

ASSISTANT COMMISSIONER FOR PATENTS WASHINGTON, D.C. 20231

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NEW APPLICATION UNDER 37 CFR § 1.53(b)

Enclosed are the following papers relating to the above-named application for patent:

Specification
2 Informal Sheets of drawings
Assignment with Cover Sheet
Declaration and Power of Attorney

	CL	AIMS AS FILED		
	NO. FILED	NO. EXTRA	RATE	CALCULATIONS
Total Claims	19 - 20 =	0	x \$18 =	\$0
Independent Claims	3 - 3 =	0	x \$78 =	\$0
Multiple Dependent Claims, if applicable			+ \$260 =	\$0
Basic Fee			\$690	
			TOTAL FEE	\$690

Please file the application and charge **Lucent Technologies Deposit Account No. 12-2325** the amount of \$690, to cover the filing fee. Duplicate copies of this letter are enclosed. In the event of non-payment or improper payment of a required fee, the Commissioner is authorized to charge or to credit **Deposit Account No. 12-2325** as required to correct the error.

The Assistant Commissioner for Patents is hereby authorized to treat any concurrent or future reply, requiring a petition for extension of time under 37 CFR § 1.136 for its timely submission, as incorporating a petition for extension of time for the appropriate length of time if not submitted with the reply.

Please address all correspondence to **Docket Administrator (Room 3C-512), Lucent Technologies Inc., 600 Mountain Avenue, P.O. Box 636, Murray Hill, New Jersey 07974-0636.** However, telephone calls should be made to me at 973-386-2992.

Respectfully,

Christopher Malvone Reg. No. 34866 Attorney for Applicant

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Date: _____

IMPROVED RF TEST PROBE

Background of the Invention

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1. Field of the Invention

The present invention relates to radio frequency circuits; more specifically, probes for testing radio frequency circuits.

2. Description of the Related Art

In the past, radio frequency circuits were tested usually using radio frequency (RF) couplers. Radio frequency couplers were built into the circuit to provide test points to monitor the radio frequency signal in the circuit under test. This technique had the disadvantage of using precious circuit card real estate as well as adding the expense of RF couplers.

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Another technique for testing RF circuits involved using RF test probes with a bayonet type tip. One of the bayonet tips was used as a ground and the second bayonet tip was used to contact a radio frequency conductor such as a microstrip in the circuit under test. The bayonet tips often provided poor contact with either the microstrip or ground. Additionally, the bayonet probe affected the circuit under test and thereby distorted the RF signal to be measured.

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Summary of the Invention

The present invention provides an inexpensive RF test probe that provides a consistent measurement of an RF signal while having minimal effect on the circuit under test. In one embodiment of the present invention, an RF test probe comprises a return conductor and a probing conductor. The probing conductor is positioned within an insulator, and a termination such as a 50 ohm resistor is electrically positioned between the ground conductor and probing conductor. The probe is used by placing a portion of the insulating material that surrounds the probe conductor in contact with a circuit such as an RF microstrip carrying an RF signal to be monitored.

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Brief Description of the Drawings

FIG. 1 illustrates the RF test probe being used to measure an RF signal carried on an RF microstrip;

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FIG. 2 is a side view of the RF test probe;

FIG. 3 is a second side view of the RF test probe;

FIG. 4 is a cross section along line AA of FIG. 2;

FIG. 5 is a cross section along line BB of FIG. 2;

FIG. 6 illustrates an alternative cross section taken along line BB of FIG. 2; and

FIG. 7 illustrates another embodiment of the RF test probe.

Detailed Description of the Invention

FIG. 1 illustrates RF test probe 10 being used to measure an RF signal carried on RF microstrip 12. Coaxial output portion 14 of RF test probe 10 carries a signal representative of the RF signal on microstrip 12 to testing equipment such as an oscilloscope or spectrum analyzer. Handle 16 is used to provide a convenient non-conductive gripping surface for the user. Signal pickup section 18 includes insulator 20 and probe conductor 22. The probe is used by contacting an outer surface of insulator 20 to the conductor carrying the RF signal to be monitored.

FIG. 2 is a side view of test probe 10. In this view, coaxial output portion 14 is shown with a threaded connector to facilitate connecting a cable used to provide a connection to testing equipment. Within handle 16, coaxial conductor 28 continues until reaching handle end 30. At handle end 30, the conductive shielding associated with the outer layer of coaxial conductor 28 is stripped away to expose a flexible insulator 20. It is possible to use the core material of the coaxial conductor as insulator 20; however, it is also possible to strip away the core material and use a flexible insulator such as a TEFLON® type material as insulator 20. (TEFLON® is a registered trademark of E. I. duPont de Nemours and Company.) Probe conductor 22, which may be the center conductor of coaxial conductor 28, continues on a curved path through insulator 20 and reenters handle 16. Once reentering handle 16, probe conductor 22 is terminated in terminator 32. Terminator 32 is electrically positioned between probe conductor 22 and the return or ground conductor of coaxial conductor 28. The return conductor of coaxial conductor 28 may be external metal sheathing 34 or may be a conductive shield positioned below a nonconductive outer shield. Terminator 32 may be a resistor or semiconductive device such as a diode. If a resistor is used, it is preferable to use a resistance value that matches the characteristic impedance of the RF circuit under test. In many circuits, the characteristic impedance is typically 50 ohms and therefore terminator 32 is typically a 50 ohm resistor.

FIG. 3 illustrates another side view of test probe 10. The view of FIG. 3 illustrates the view of FIG. 2 rotated 90 degrees.

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FIG. 4 is a cross section taken along line AA of FIG. 2. The cross section illustrates conductor 22 within insulator 20 and it also illustrates that insulator 20 has a circular cross section. Additionally, arrow 40 illustrates the direction of the RF signal in the circuit under test relative to the probe to produce the maximum signal conducted through coaxial conductor 28. As a result, the probe may be rotated to determine the propagation direction of the RF signal being monitored.

FIG. 5 is a cross section taken along line BB of FIG. 2. FIG. 5 once again illustrates that the cross section of insulator 20 is circular. The circular cross section offers the advantage of allowing the probe to be held at different angles when making contact with a conductor carrying an RF signal to be monitored. The circular cross section permits the probe to be held at different angles while maintaining the same distance between probe conductor 22 and the conductor carrying the signal to be monitored. This results in consistent measures of the signal to be monitored independent of the angle at which the probe is held.

FIG. 6 illustrates an alternative cross section taken along line BB of FIG. 2. In this case, insulator 20 has at least a partial cross section that is substantially circular in a plane that is substantially perpendicular to probe conductor 22 that is passing through the cross section. This embodiment offers the advantage of providing a circular cross section along the areas where the probe would most likely contact the circuit under test while providing a flat cross section in areas where the probe is less likely to contact a circuit carrying a signal to be monitored.

FIG. 7 illustrates an alternative embodiment to the invention. In this embodiment, probe 50 includes handle 52 and coaxial conductor 54. Coaxial conductor 54 may include a threaded end at end section 56 to facilitate connection to a coaxial cable for connection to testing equipment. At end 58 of handle 52 probe conductor 60, which may be the center conductor of coaxial conductor 54, emerges from the handle without outer conductive shield 62 of coaxial conductor 54. It should be noted that outer shield 62 may also act as a return or ground conductor. Probe conductor 60 extends out from handle 52 and then returns into handle 52 at position 64. After reentering handle 64, conductor 60 is terminated in terminator 66 which is electrically positioned between conductor 60 and return conductor 62. As mentioned earlier, terminator 66 may be a resistor or semiconductor device such as a diode. Insulator 68 is positioned adjacent to the portion of probe conductor 60 that extends out of handle 52. The outer surface of insulator 68 is used to make contact to a conductor carrying an RF signal to be monitored. Insulator 68 may be attached directly to conductor 60 or it may be held in a spaced relationship to conductor 60 and attached to handle 52 for mechanical support.

Other embodiments of the invention may include configurations that permit an insulated surface adjacent to a probing conductor to be placed in contact with an RF circuit under test while a terminator is placed between the probe conductor and a return or ground conductor.

The invention claimed is:

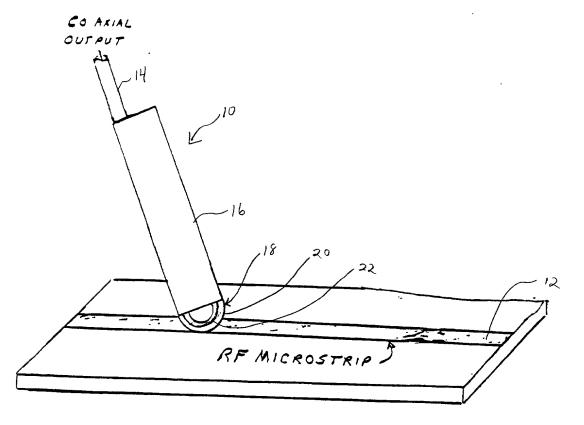
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1	1. An RF probe, comprising:
2	a conductive return;
3	a insulating contact surface;
4	a probe conductor positioned adjacent to the insulating contact surface; and
5	a termination electrically positioned between the conductive return and the probe
6	conductor.
1	2. The RF probe of claim 1, wherein the conductive return is a ground return.
1	3. The RF probe of claim 1, wherein the termination is a resistor.
1	4. The RF probe of claim 3, wherein the termination is a resistor of approximately 50
2	ohms.
1	5. The RF probe of claim 1, wherein the termination is a semiconductor device.
1	6. The RF probe of claim 5, wherein the termination is a diode.
1	7. An RF probe, comprising:
2	a conductive return;
3	a probe conductor positioned within an insulator; and
4	a termination electrically positioned between the conductive return and the probe
5	conductor.
1	8. The RF probe of claim 7, wherein the conductive return is a ground return.
1	9. The RF probe of claim 7, wherein the termination is a resistor.
1	10. The RF probe of claim 9, wherein the termination is a resistor of approximately 50
2	ohms

11. The RF probe of claim 7, wherein the termination is a semiconductor device.

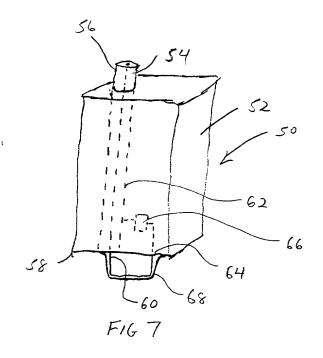
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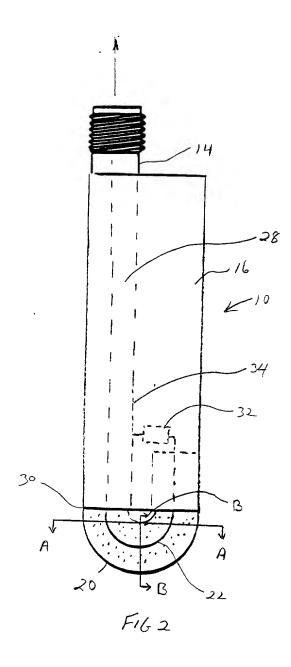
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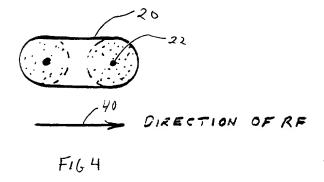
1	12. The RF probe of claim 11, wherein the termination is a diode.
1	13. The RF probe of claim 7, wherein the insulator has at least a partial cross section that
2	is substantially circular in a plane substantially perpendicular to the probe conductor.
1	14. The RF probe of claim 13, wherein the conductive return is a ground return.
1	15. The RF probe of claim 13, wherein the termination is a resistor.
1	16. The RF probe of claim 15, wherein the termination is a resistor of approximately 50
2	ohms.
1	17. The RF probe of claim 13, wherein the termination is a semiconductor device.
1	18. The RF probe of claim 17, wherein the termination is a diode.
1	19. An RF probe, comprising:
2	a conductive return;
3	a probe conductor positioned within an insulator, the probe conductor being curved and
4	the insulator having at least a partial cross section that is substantially circular in a plane
5	substantially perpendicular to the probe conductor; and
6	a termination electrically positioned between the conductive return and the probe

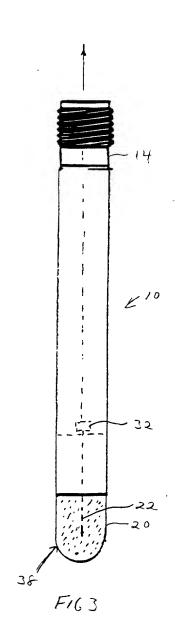


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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Declaration and Power of Attorney

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe I am an original, first and sole inventor of the subject matter which is claimed and for which a patent is sought on the invention entitled **Improved RF Test Probe** the specification of which is attached hereto.

I hereby state that I have reviewed and understand the contents of the above identified specification, including the claims, as amended by an amendment, if any, specifically referred to in this oath or declaration.

I acknowledge the duty to disclose all information known to me which is material to patentability as defined in Title 37, Code of Federal Regulations, 1.56.

I hereby claim foreign priority benefits under Title 35, United States Code, 119 of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed:

None

I hereby claim the benefit under Title 35, United States Code, 120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, 112, I acknowledge the duty to disclose all information known to me to be material to patentability as defined in Title 37, Code of Federal Regulations, 1.56 which became available between the filing date of the prior application and the national or PCT international filing date of this application:

None

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

I hereby appoint the following attorney(s) with full power of substitution and revocation, to prosecute said application, to make alterations and amendments therein, to receive the patent, and to transact all business in the Patent and Trademark Office connected therewith:

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Charles L. Warren	(Reg. No. 27407)
Eli Weiss	(Reg. No. 17765)

Please address all correspondence to the Docket Administrator (Rm. 3C-512), Lucent Technologies Inc., 600 Mountain Avenue, P. O. Box 636, Murray Hill, New Jersey 07974-0636. Telephone calls should be made to Christopher Malvone by dialing 973-386-2992.

Full name of sole inventor: Robert Evan Myer

Inventor's signature Robot Evan Mya Date 9/7/00

Residence: Denville, Morris County, New Jersey

Citizenship: United States of America

Post Office Address: 30 Spear Lane

Denville, New Jersey, 07834